

MODEL NO. : _	TM104SBH04
ISSUED DATE:	2010-9-7
VERSION :	Ver 1.0

■ Preliminary Specification ☐ Final Product Specification

Customer	•
Custonie	•

Approved by		Notes	

SHANGHAI TIANMA Confirmed:

Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice



Table of Contents

Tab	le of Contents	2
1	General Specifications	4
2	INPUT TERMINALS PIN ASSIGNMENT	4
3	ABSOLUTE MAXIMUM RATINGS	8
4	ELECTRICAL CHARACTERISTICS	<u> </u>
5	INTERFACE TIMING	
6	Optical Characteristics	15
7	Environmental / Reliability Tests	
8	Mechanical Drawing	
9	Packaging Drawing	
10	Precautions for Use of LCD Modules	





\checkmark

Record of Revision

Rev	Issued Date	Description	Editor
1.0	2010-9-7	New release	Kelly hu



1 General Specifications

	Feature	Spec	
	Size	10.4 inch	
	Resolution	800(RGB) x 600	
	Interface	LVDS 8-bit/6-bit	
	Color Depth	16.7M/262K	
	Technology Type	a-Si	
Display Spec.	Pixel Pitch (mm)	0.264x0.264	
	Pixel Configuration	R.G.B. Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment(Up Polarizer)	Anti-Glare(3H)	
	Viewing Direction	12 o'clock	
	Gray Scale Inversion Direction	6 o'clock	
	LCM (W x H x D) (mm)	243.00x179.40x10	
Mechanical	Active Area(mm)	211.20x158.40	
Characteristics	With /Without TSP	With TSP	
	Weight (g)	TBD	

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: ± 5%

2 INPUT TERMINALS PIN ASSIGNMENT

2.1 TFT LCD Panel

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 4 of 23



CN1 Connector type: 107A20-0021RA-G3-R

No	Symbol	I/O	Description	Comment
1	VDD	Р	Power Supply	
2	VDD	Р	Power Supply	
3	GND	Р	Ground	
4	DPS	1	Reverse Scan Function [H: Enable; L/NC: Disable]	Note3
5	RxIN0-	I	LVDS receiver signal channel 0. LVDS Differential	Note2
6	RxIN0+	I	Data Input (R0, R1, R2, R3, R4, R5, G0)	Notez
7	GND	Р	Ground	
8	RxIN1-	ı	LVDS receiver signal channel 1. LVDS Differential	Note2
9	RxIN1+	I	Data Input (G1, G2, G3, G4, G5, B0, B1)	Notez
10	GND	Р	Ground	
11	RxIN2-	I	LVDS receiver signal channel 2	Note2
12	RxIN2+	I	LVDS Differential Data Input (B2, B3, B4, B5, DE)	NOIGZ
13	GND	Р	Ground	
14	RxCLKIN-	I	LVDS receiver signal clock	Note2
15	RxCLKIN+	I	EVBO receiver signal clock	NOICZ
16	GND	Р	Ground	
17	RxIN3-	I	LVDS receiver signal channel 3, NC for 6-bit LVDS Input. LVDS Differential Data Input (R6, R7, G6, G7,	Note2
18	RxIN3+	I	B6, B7, RSV) for 8-bit LVDS input.	Notez
19	AGMode	I	Aging Mode setting [H: Aging Mode; L/NC: Normal]	
20	SEL68	Р	6-bit/8-bit LVDS data input selection [H: 8-bit L/NC: 6-bit]	Note2

P: Power/GND; I: input pin;

Table 2.1 input terminal pin assignment

Note1: CN1 Match Connector type: DF19G-20S-1C or compatible



Note2: LVDS 6-bit data mapping when SEL68=L/NC as follows:

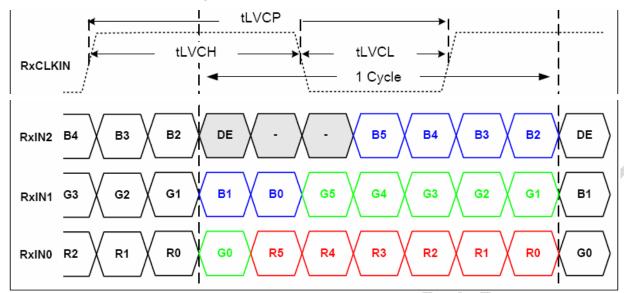


Figure 2.1.1 Input signal data mapping

LVDS 8-bit data mapping when SEL68=H as follows:

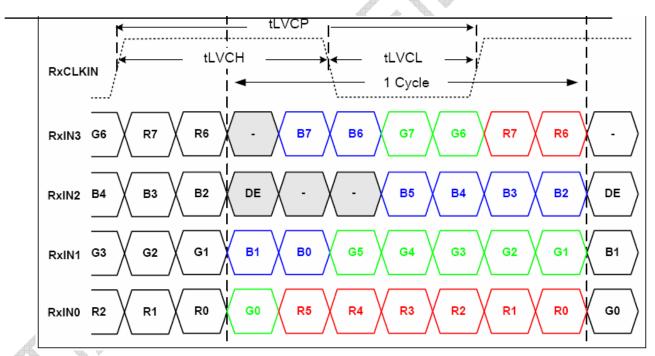


Figure 2.1.2 Input signal data mapping

Note3: DPS: Scan direction setting

DPS	Horizontal Scan direction	Vertical Scan direction
High	Right to left	Down to up
Low/NC	Left to right	Up to down

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.



2.2 CN2(Backlight Connector)

Connector type: 3808K-F05N-03R (ENTERY)

No	Symbol	I/O	Description	Remark
1	VCC	Р	Power for LED driving circuit.12.0V input.	
2	PGND	Р	Ground for LED driving circuit. 0V input.	
3	EN	I	Backlight enable setting. High: enabled; Low: disable.	
4	Dimming	I	PWM signal for adjusting luminance of backlight.	
5	NC	-	No connection	

Match connector: H208K–P05N-02B (ENTERY)

2.3 CN3(TSP interface)

No	Symbol	I/O	Description	Remark
1	Y2	I	ITO film	
2	X2	I	ITO glass	
3	Y1	I	ITO film	
4	X1	I	ITO glass	

CN3(TSP FPC) Match Connector: SFW4R-1STAE1 LF(for reference);

Page: 7 of 23

3 ABSOLUTE MAXIMUM RATINGS

GND=0V, Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Power Voltage	VDD	-0.3	5.0	V	
Power for LED driving circuit	VCC	-0.3	13.5	V	
Input voltage	V _{IN}	-0.3	5.0	V	Note1
Input voltage for backlight	V _t	-0.5	7.0	V	Note2
Operating Temperature	T _{OPR}	-20	70	$^{\circ}$	
Storage Temperature	T _{STG}	-30	80	$^{\circ}$ C	

 $Note 1: \quad V_{IN} \ represents \ RxIN0\pm, RxIN1\pm, RxIN2\pm, RxIN3\pm, RxCLKIN\pm, DPS, AGMode, SEL 68.$

Note2: V_t represents EN and Dimming.

Table 3.1 Absolute maximum rating

Page: 8 of 23

4 ELECTRICAL CHARACTERISTICS

4.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Supply Voltage	VDD	3.0	3.3	3.6	V	
LVDS Differential input high	\/			1400	ma\ /	1/2/
threshold	V_{TH}	-	-	+100	mV	VcmLvds=1.2V
LVDS Differential input low	\/	100			A my	V _{CMLVDS} =1.2V
threshold	V_{TL}	-100	-	-	mV	VCMLVDS-1.2V
Differential input voltage	VID	0.1	-	0.6	V	
LVDS input common mode	V/	11/2-1/2		1.4 (1)(4.1/2)	V	
voltage	Vcmlvds	Vıb /2	-	1.4-(V _{ID} /2)	V	
Common Electrode	VCOM	_	4.30	X -1	V	Note1
Driving Signal			1.00			110101
Sync Frequency	FVD	-	60	70	Hz	
VDD Power Consumption	I _{VDD}		340	380	mA	Note2

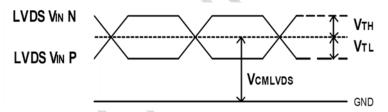


Figure 4.1.1 LVDS DC timing diagram

Note1: For different LCM, the value may have a bit of difference.

Note2: To test the current dissipation, use "all Black Pattern" test pattern.

Page: 9 of 23

4.2 Driving Backlight

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Power for LED driving circuit	VCC	10.8	12.0	12.6	V	
Current of Backlight Power	I _{VCC}	-	0.32	-	Α	100% PWM Duty
Backlight Power Consumption	W _{BL}	-	3.84	-	W	100% PWM Duty
Dimming Frequency	F _{PWM}	200	-	20K	Hz	
Dimming duty cycle	-	0	-	100%	-	
High Level Input Voltage	V _{IH}	2	-	-	٧	For Dimming, EN pin
Low Level Input Voltage	V _{IL}	-	-	0.8	V	For Dimming, EN pin
LED Life Time	-	25000	(50000)	-	hrs	Note 1

Note1: Optical performance should be evaluated at Ta=25℃ only.

If LED is driven by high current, high ambient temperature & humidity condition, the life time of LED will be reduced.

Operating life means brightness goes down to 50% initial brightness.

Typical operating life time is estimated data.

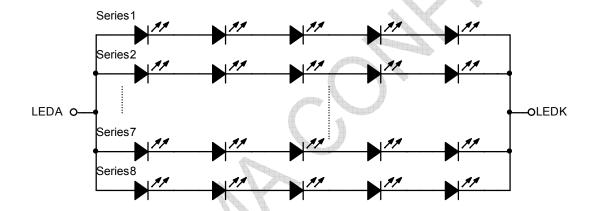
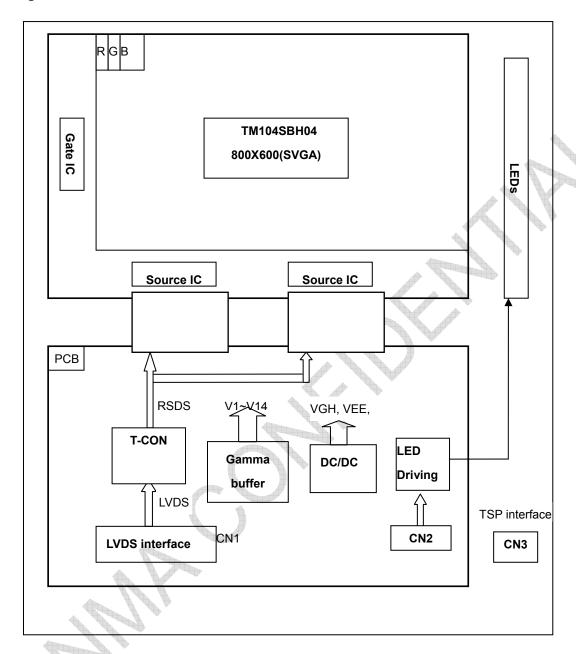


Figure 4.2 LED connection of backlight

Page: 10 of 23

4.3 Block Diagram



Page: 11 of 23

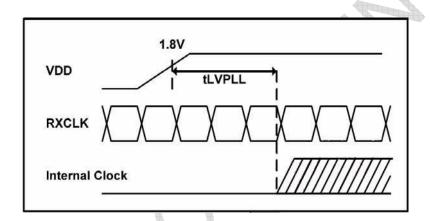
5 INTERFACE TIMING

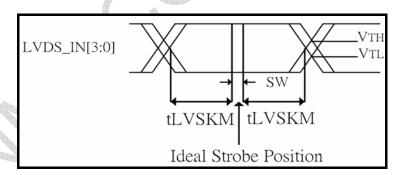
5.1 Timing Parameter

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Condition
Clock period	tLVCP	20.0	25	31.25	ns	
Clock high time	tLVCH	-	14.29	-	ns	
Clock low time	tLVCL	-	10.71	-	ns	
PLL wake-up time	tLVPLL	-	-	1	ms	
Input skew marign	tLVSKM	400	-	-	ps	f=85MHz

Table 5.1 timing parameter





SW: Setup and Hold time

Page: 12 of 23



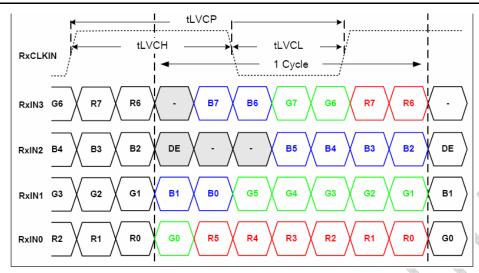


Figure 5.1 Input signal data timing

5.2 Power On/Off Sequence

Item	Symbol	Min	Тур	Max	Unit	Remark
VDD 3.0V to signal starting	Tp1	5	-	50	ms	
Signal starting to backlight on	Tp2	150	-	-	ms	
Signal off to VDD 3.0V	Тр3	5	-	50	ms	
Backlight off to signal off	Tp4	150	-	-	ms	

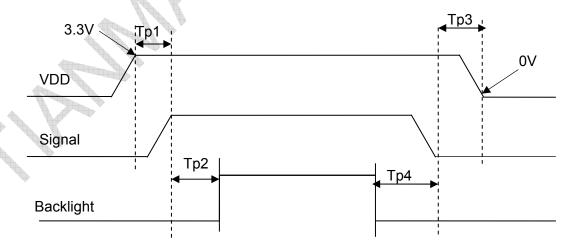


Figure 5.2 Interface power on/off sequence

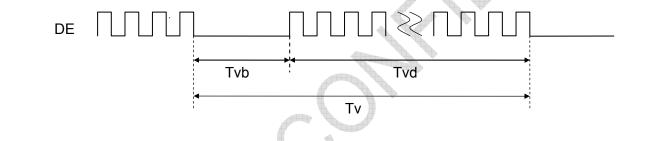
The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

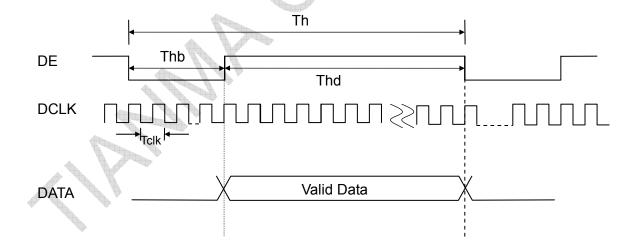
Page: 13 of 23

5.3 Recommended Input Timing of LVDS transmitter

Item	Parameter	Symbol	Min.	Тур.	Max.	Unit	Remarks
Dclk frequency		1/Tclk	32	40	50	MHz	
Horizontal	Horizontal total	Th	866	1056	1064	Tclk	
section	Horizontal blanking	Thb	66	256	264	Tclk	
3000001	Valid Data Width	Thd	800	800	800	Tclk	
	Frame rate	-	-	60	70	Hz	
Vertical	Vertical total	Tv	604	628	800	Th	
section	Vertical blanking	Tvb	4	28	200	Th	
	Valid Data Width	Tvd	600	600	600	Th	

Note: DE signal is necessary.







6 Optical Characteristics

Item		Symbol	Condition	Min	Тур.	Max.	Unit	Remark
		θТ		60	70	-		
View Ang	\ <i>r</i> .		CR≧10	50	60	-	Dograd	Note 2
View Ang	JIES	θL	CR≡ IU	60	70	-	Degree	Note 2
		θR		60	70	-		
Contrast F	Ratio	CR	θ=0°	400	500		-	Note1,3
Response	Timo	Ton	25 ℃		25	40	ms	Note1 4
Nesponse	TITILE	Toff	25	ı	25	40	Degree Note 2	
	White	x		0.2995	0.3005	0.3017		
	VVIIILE	у		0.3372	0.3381	0.3390		
	RED	x		0.6128	0.6136	0.6152		
Chromaticity	NLD	у		0.3537	0.3538	0.3538		Note1.5
Chilomaticity	GREEN	x	-	0.3107	0.3114	0.3123	_	Note 1,5
	GILLIN	у		0.5322	0.5335	0.5349		
	BLUE	x		0.1313	0.1316	0.1321		
	BLOL	у		0.1406	0.1415	0.1420		
Uniformity		U	1	ı	80	-	%	Note1,6
NTSC	;	4-	-	-	47	-	%	Note 5
Luminar	nce	L	<u> </u>	220	260	-	cd/m2	Note1,7

Test Conditions:

- 1. VDD=3.3V, I_L =20mA(Backlight current), the ambient temperature is 25 $^{\circ}$ C.
- 2. The test systems refer to Note 1 and Note 2.

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

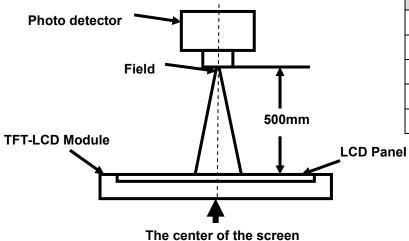
Page: 15 of 23

SHANGHAI TIANMA MICRO-ELECTRONICS

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when

measuring the center area of the panel.



ItemPhoto DetectorFieldContrast RatioLuminanceSR-3A1°ChromaticityLum UniformityBM-7A2°

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

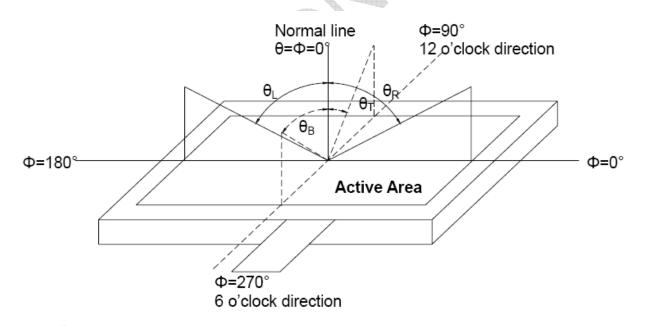


Fig. 1 Definition of viewing angle

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 16 of 23

SHANGHAI TIANMA MICRO-ELECTRONICS

Note 3: Definition of contrast ratio

Contrast ratio (CR) =
\[\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}} \]

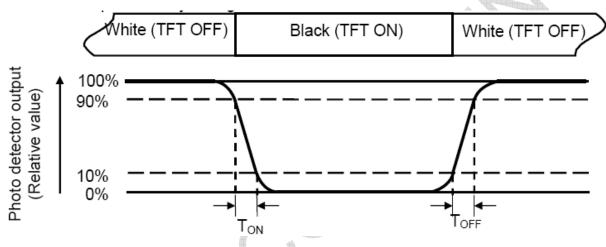
"White state ": The state is that the LCD is driven by Vwhite.

"Black state": The state is that the LCD is driven by Vblack.

Vwhite: To be determined **V**black: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931) Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 17 of 23



each measuring area.

Luminance Uniformity(U) = Lmin/ Lmax

L-----Active area length W----- Active area width

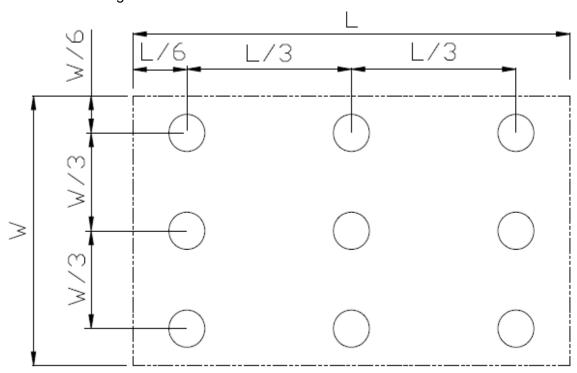


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point

Page: 18 of 23



SHANGHAI TIANMA MICRO-ELECTRONICS

7 Environmental / Reliability Tests

No	Test Item	Condition	Remark
1	High Temperature	Ts=+70℃, 240hrs	Note1
I	Operation		IEC60068-2-1,GB2423.2
2	Low Temperature	Ta=-20°C, 240hrs	IEC60068-2-1
	Operation		GB2423.1
3	High Temperature	Ta=+80°C, 240hrs	IEC60068-2-1
3	Storage (non-operation)		GB2423.2
4	Low Temperature	Ta=-30℃, 240hrs	IEC60068-2-1
4	Storage (non-operation)		GB2423.1
	High Temperature &	Ta = +60℃, 90% RH max,240 hours	Note2
5	High Humidity Opera-		IEC60068-2-78
	tion		GB/T2423.3
	Thermal Shock	-30℃ 30 min~+80℃ 30 min,	Start with cold temperature,
6	(non-operation)	Change time:5min, 30 Cycles	End with high temperature,
	(non-operation)		IEC60068-2-14:1984,GB2423.22
		C=150pF,R=330Ω,	IEC61000-4-2
7	Electro Static Discharge	Air:±15Kv,	GB/T17626.2
'	(operation)	Contact:±8Kv,	
		10times/terminal	
		Frequency range:10~55Hz,	
8	Vibration	Stroke:1.5mm	IEC60068-2-6
ľ	(non-operation)	Sweep:10Hz~55Hz~10Hz 2hours for	GB/T2423.10
		each direction of x.y.z (6 hours for total)	
9	Shock (non-operation)		IEC60068-2-27
		each direction	GB/T2423.5
10	Package Drop Test	Height:80 cm,1 corner, 3 edges, 6	IEC60068-2-32
	- dollage	surfaces	GB/T2423.8
		Random Vibration:	IEC60068-2-34
		0.015GxG/Hz for 5-200Hz,	GB/T2423.11
11	Package Vibration Test	-6dB/Octave from 200-500Hz	
		2 hours for each direction of X,Y,Z	
		(6 hours for total)	

Note1: Ts is the temperature of panel's surface.

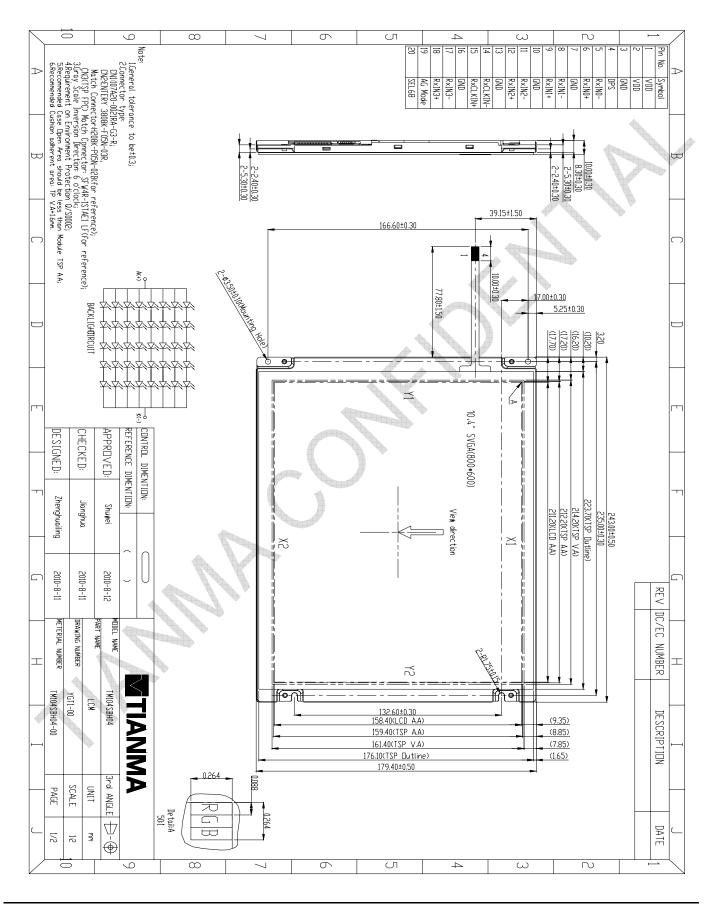
Note2: Ta is the ambient temperature of sample.

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 19 of 23



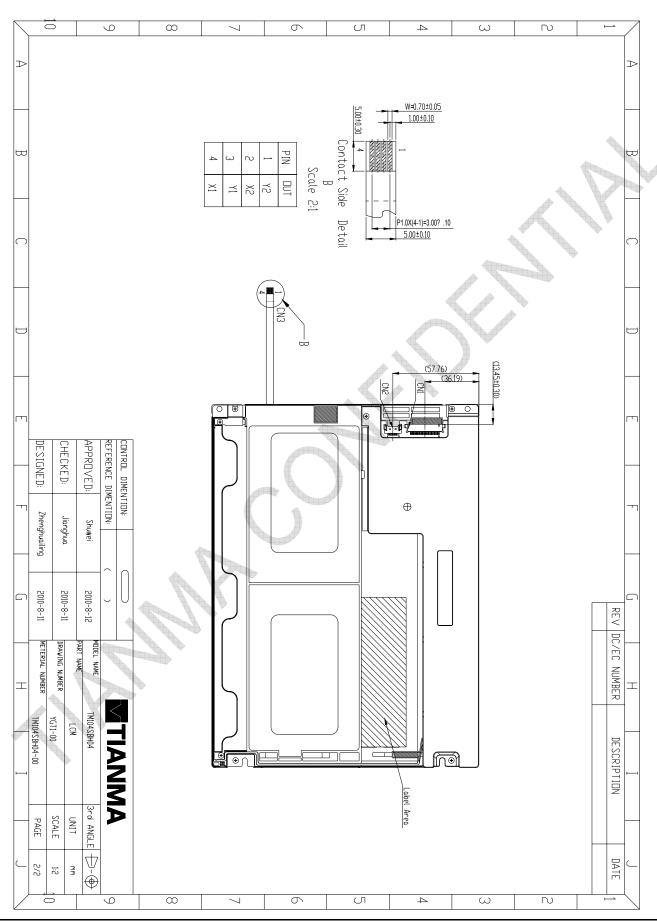
8 Mechanical Drawing



The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 20 of 23



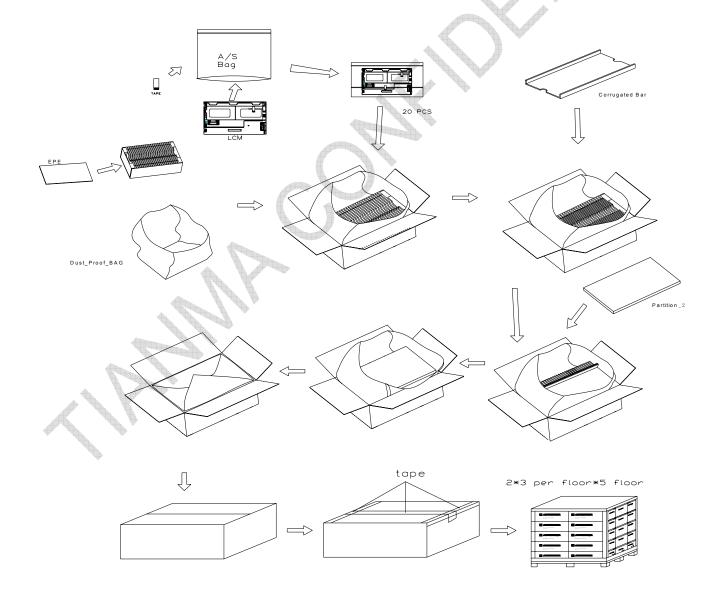


The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.



9 Packaging Drawing

N o	Item	Model (Material)	Dimen- sions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM104SBH04	243x179.4x10	TBD	20	
2	Partition_1	Corrugated paper	513x333x217	TBD	1	
3	Anti-static Bag	PE	265x255x0.05	0.0054	20	
4	Dust-Proof Bag	PE	700x530	TBD	1	
5	Partition_2	Corrugated Paper	505x332	0.1	1	
6	Corrugated Bar	Corrugated paper	413x285	TBD	1	
7	Carton	Corrugated paper	530x350x250	1.12	1	*
8	Total weight			TBD		



The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 22 of 23

10 Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:—Water, Ketone, Aromatic solvents

- 10.1.6. Do not attempt to disassemble the LCD Module.
- 10.1.7. If the logic circuit power is off, do not apply the input signals.
- 10.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- a. Be sure to ground the body when handling the LCD Modules.
- b. Tools required for assembly, such as soldering irons, must be properly ground.
- c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 10.2 Storage precautions
- 10.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2. The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C ~ 40° C Relatively humidity: ≤80%

- 10.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

Page: 23 of 23